MSKSEMI















ESD

TVS

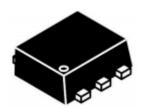
TSS

MOV

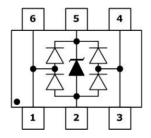
GDT

PLED

Broduct data sheet



SOT-666



PIN CONFIGURATION

FEATURES

- Ultra low leakage: nA level
- Operating voltage: 5V
- Low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test Air discharge: ±15kV

Contact discharge: ±8kV

- IEC61000-4-4 (EFT) 40A (5/50ns)

RoHS Compliant

APPLICATIONS

- USB 2.0 power and data line
- Set-top box and digital TV
- Digital video interface (DVI)
- **Notebook Computers**
- SIM Ports
- 10/100 Ethernet

Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	Ррр	120	W	
ESD per IEC 61000-4-2 (Air)	Vesd	±15	Kv	
ESD per IEC 61000-4-2 (Contact)	VESD	±8	IXV	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$	
Storage Temperature Range	Тѕтл	-55 to +150	°C	

Electrical Characteristics (TA=25°C unless otherwise specified)

P/N	Marking	V _{RWM} (V)	V _{BR} (V)	I⊤ (mA)	V₀ @1A	(Max)	(@A)	I _R µA (Max)	C (Pf) (Typ.)
USBLC6-2P6-MS	F	5	6	1	13	30	4	1	0.9

Characteristic Curves

Fig1. 8/20 µs Pulse Waveform

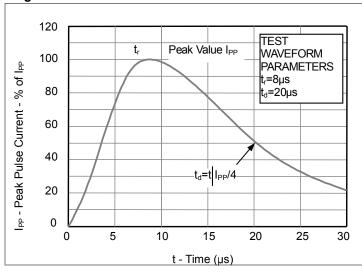


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

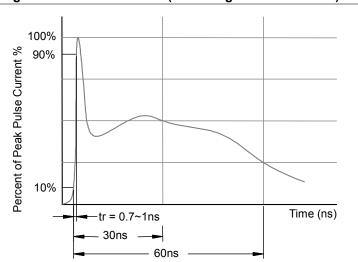
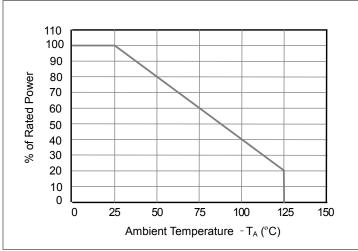


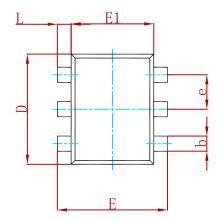
Fig3. Power Derating Curve

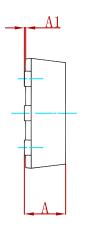


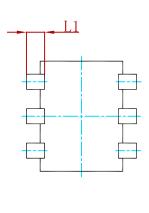


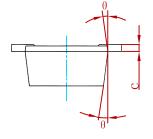


PACKAGE MECHANICAL DATA



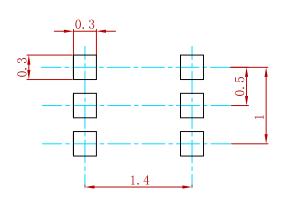






Symbol	Dimensions	In Millimeters	Dimensions in inches		
Symbol	Min.	Max.	Min.	Max.	
A	0. 525	0.600	0.021	0.024	
A1	0.000	0.050	0.000	0.002	
е	0.450	0. 550	0.018	0.022	
С	0.090	0.160	0.004	0.006	
D	1.500	1.700	0.059	0.067	
b	0.170	0. 270	0.007	0.011	
E1	1. 100	1. 300	0.043	0.051	
Е	1.500	1.700	0.059	0.067	
L	0.100	0.300	0.004	0.012	
L1	0. 200	0.400	0.008	0.016	
θ		7 ORFF		7 ORFF	

Suggested Pad Layout



- 1.Controlling dimension:in millimeters. 2.General tolerance:±0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
USBLC6-2P6-MS	SOT-666	3000



Attention

- Any and all MSKSEMI Semiconductor products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your MSKSEMI Semiconductor representative nearest you before using any MSKSEMI Semiconductor products described or contained herein in such applications.
- MSKSEMI Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specificationsof any andall MSKSEMI Semiconductor products described orcontained herein.
- Specifications of any and all MSKSEMI Semiconductor products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- MSKSEMI Semiconductor. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with someprobability. It is possiblethat these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits anderror prevention circuitsfor safedesign, redundant design, and structural design.
- In the event that any or all MSKSEMI Semiconductor products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from theauthorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of MSKSEMI Semiconductor.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. MSKSEMI Semiconductor believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringementsof intellectual property rights or other rightsof third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. Whendesigning equipment, referto the "Delivery Specification" for the MSKSEMI Semiconductor productthat you intend to use.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for ESD Suppressors / TVS Diodes category:

Click to view products by MSKSEMI manufacturer:

Other Similar products are found below:

60KS200C D18V0L1B2LP-7B D5V0F4U5P5-7 DESD5V0U1BB-7 NTE4902 P4KE27CA P6KE11CA P6KE39CA-TP P6KE8.2A

SA110CA SA60CA SA64CA SMBJ12CATR SMBJ33CATR SMBJ8.0A ESD101-B1-02ELS E6327 ESD105-B1-02EL E6327 ESD112-B1
02EL E6327 ESD119B1W01005E6327XTSA1 ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF

3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7

SCM1293A-04SO ESD200-B1-CSP0201 E6327 SM12-7 SMLJ45CA-TP CEN955 W/DATA 82350120560 VESD12A1A-HD1-GS08

CPDUR5V0R-HF CPDQC5V0U-HF CPDQC5V0USP-HF CPDQC5V0-HF D1213A-01LP4-7B D1213A-02WL-7 MMAD1108/TR13

5KP100A 5KP15A 5KP18A 5KP48A 5KP90A 5KP90CA